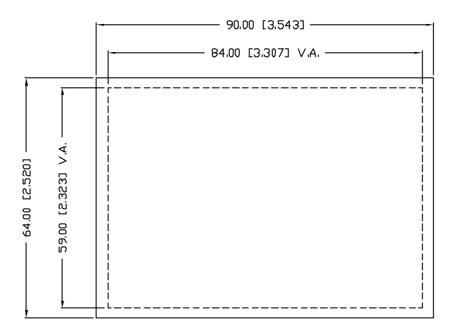
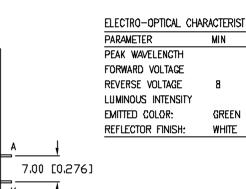
UNCONTROLLED DOCUMENT

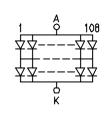
SSB-C





LIMITS OF SAFE OPERATION AT 2 PARAMETER STEADY CURRENT POWER DISSIPATION DERATE FROM 25°C. PER DIE OPERATING, STORAGE TEMP. SOLDERING TEMP. 2.0mm FROM BODY





UNCONT

*UNLESS OTHERWISE SPECIFED TOLERANCES PER DECIMAL PRECISION ARE; X=±1 (±0.039), XX=±0.5 (±0.020), XXX=±0.25 (±0.010), XXXX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD LENGTH=±0

PART NUMBER REV. SSB-COB8459GW

84mm x 59mm VIEW AREA, CHIP ON BOARD LED BACKLIGHT, 565nm GREEN, 216 CHIPS, 4.2V @ 1.08A.

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RELIABILITY NOTE

OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT

SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE.

PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.

